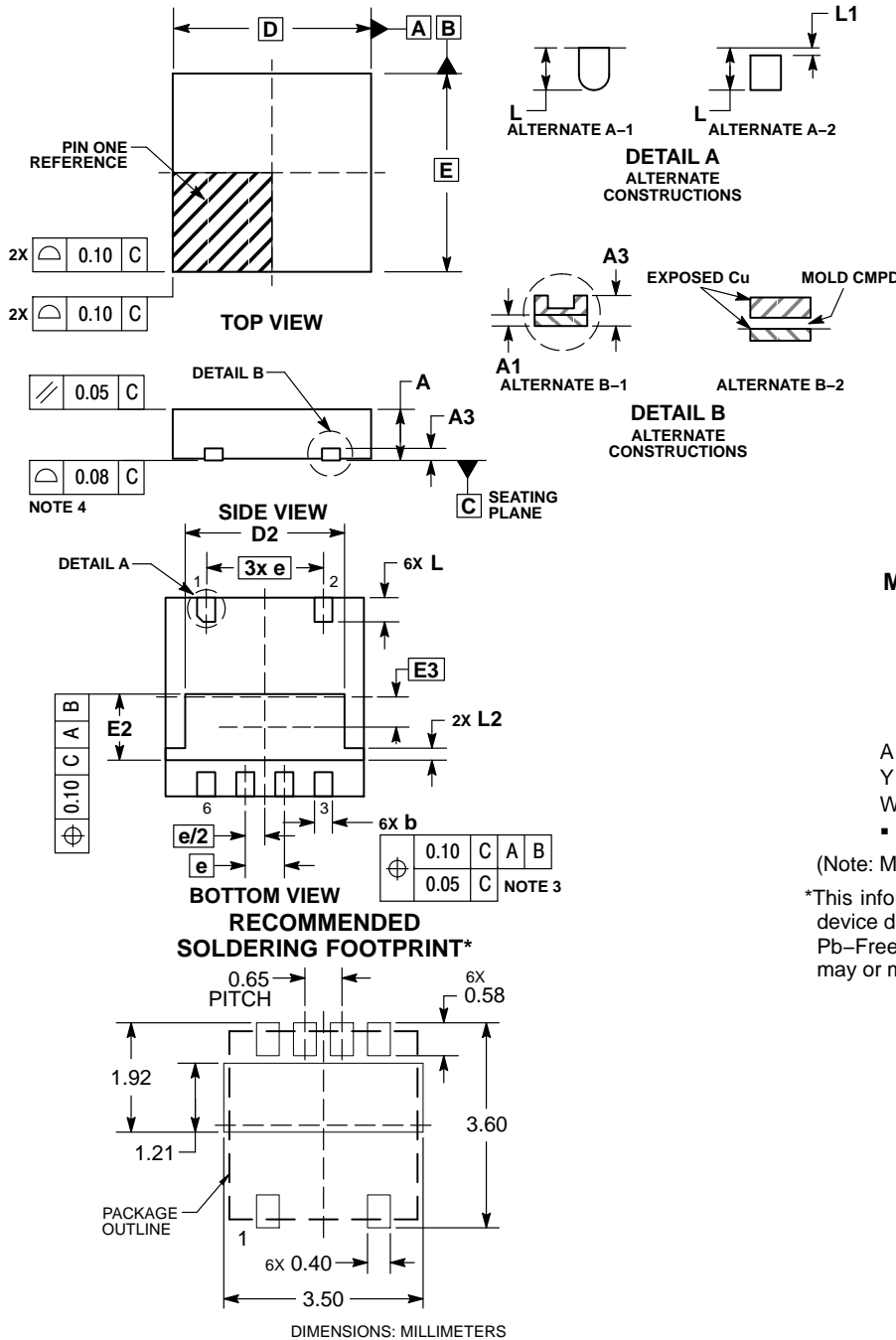


SCALE 2:1

DFN6 3.3x3.3, 0.65P
CASE 506DF
ISSUE B

DATE 23 JUN 2016

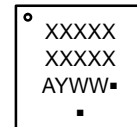


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. FOR DEVICE OPN CONTAINING W OPTION, DETAIL A ALTERNATE CONSTRUCTION A-2 AND DETAIL B ALTERNATE CONSTRUCTION B-2 ARE NOT APPLICABLE.

MILLIMETERS		
DIM	MIN	MAX
A	0.80	0.90
A1	0.00	0.05
A3	0.20	REF
b	0.25	0.35
D	3.30	BSC
D2	2.55	2.75
E	3.30	BSC
E2	1.00	1.20
E3	0.50	BSC
e	0.65	BSC
L	0.35	0.45
L1	0.00	0.15
L2	0.20	REF

GENERIC MARKING DIAGRAM*



- A = Assembly Location
- Y = Year
- WW = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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